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PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

Akihiro MURATA

Application No.: 09/245,288

Filed: February 5, 1999

Docket No.: 101937

For: SEMICONDUCTOR APPARATUS SUBSTRATE, SEMICONDUCTOR APPARATUS, AND METHOD OF MANUFACTURING THEREOF AND ELECTRONIC APPARATUS

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PRELIMINARY AMENDMENT

Director of the U.S. Patent and Trademark Office  
Washington, D. C. 20231

Sir:

Further to the July 19 personal interview with Examiner Graybill and prior to initial examination of the continued prosecution application filed July 2, 2001, please amend the above-identified application as follows:

IN THE CLAIMS:

Please replace claims 1 and 7 as follows:

1. (Twice Amended) A semiconductor apparatus, comprising:
- a substrate main body having a delineated mounting surface for mounting the semiconductor device;
  - a plurality of leads formed on the mounting surface, the plurality of leads radially extending from a peripheral area toward a central area of the substrate main body;
  - and

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